

CRYSTAL OSCILLATOR (SPXO)

OUTPUT: CMOS





Product Number

SG2016CAN: X1G004801xxxx00 SG-210STF: X1G004171xxxx00 SG3225CAN: X1G005961xxxx15 SG5032CAN: X1G004451xxxx00 SG7050CAN: X1G004481xxxx00

SG2016 / 3225 / 5032 / 7050CAN SG-210STF

• Frequency range : 1.2 MHz to 75 MHz (SG2016CAN)

1 MHz to 75 MHz (other than the above)

Supply voltage
 Function
 Operating temperature
 1.8 V to 3.3 V Typ.
 Standby(s̄T)
 C to +105 °C











SG-210STF SG3 (2.5 x 2.0 mm) (3.2 x

(3.2 x 2.5 mm) (5.0 x 3.2 mm)

2CAN SG7050CAN 2 mm) (7.0 x 5.0 mm)

Specifications (characteristics)

Item	Symbol		Specifications			Cond	litions / Remar	ks
Output frequency range fo			1.2 MHz to 75 MHz		SG2016CAN Please contact us about availa		ıs about available	
Output frequency range	10	1 MHz to 75 MHz		All others	S	frequencies.		
		1.60 V to 3.63 V		1 MHz ≤	fo ≤ 60 MHz,	T_use = +105 °C		
Supply voltage	Vcc	1.71 V to 3.63 V			60 MHz < fo ≤ 75 MHz, T_use = +85 °C Max. Refer to figure *1			
			2.25 V to 3.63 V		60 MHz < fo ≤ 75 MHz, T_use = +105 °C Max.			
Charage town areture	T ata		-55 °C to +125 °C		SG2016CAN			
Storage temperature	T_stg		-40 °C to +125 °C		All others			
Operating temperature	T_use	-20 °C to +70 °C	C, -40 °C to +85 °C, -4	0 °C to +105 °C	See of fig	See of figure *1		
			±25 × 10 ⁻⁶ , ±50 × 10 ⁻⁶		-20 °C to	+70 °C		
Frequency tolerance	f_tol		±50 × 10 ⁻⁶		-40 °C to	-40 °C to +85 °C		
			$\pm 50 \times 10^{-6}, \pm 100 \times 10^{-6}$ -40 °C to +105 °C					
		V _{CC} = 1.8 V ± 10 %	V _{CC} = 2.5 V ± 10 %	V _{CC} = 3.3 V ± 10 %				
	lcc	1.5 mA Max.	1.6 mA Max.	1.8 mA Max.	No load condition, 1 MHz ≤ fo ≤ 20 MHz			
Current consumption		1.8 mA Max.	2.0 mA Max.	2.2 mA Max.	No load condition, 20 MHz < fo ≤ 40 MHz			
		2.1 mA Max.	2.4 mA Max.	2.6 mA Max.	No load condition, 40 MHz < fo ≤ 60 MHz			
	2.4 mA Max. 2.8 mA Max. 3.0 mA Max.		3.0 mA Max.	No load condition, 60 MHz < fo ≤ 75 MHz		Hz		
Stand-by current	I_std	2.1 μA Max. 2.5 μA Max. 2.7 μA Max.		2.7 µA Max.	ST =GN	ID		
Symmetry	SYM		45 % to 55 %		50 % Vc	c level, L_CM	OS ≤ 15 pF	
	Voн		90 % V _{CC} Min.		Іон	1.8 V ± 10 % -1.5 mA	2.5 V ± 10 % -3 mA	3.3 V ± 10 % -4 mA
Output voltage	VoL		10 % V _{CC} Max.		I _{OL}	1.5 mA	3 mA	4 mA
Output voltage	V _{OH-2}	V _{CC} - 0.4 V Min.		I	1.8 V±10 % -3 mA	2.5 V±10 % -4 mA	3.3 V±10 % -6 mA	
	V _{OL-2}	0.4 V Max.			I _{OH}	3 mA	4 mA	6 mA
Output load condition (CMOS)	L_CMOS	15 pF Max.						
Input voltage	V _{IH}	80 % V _{CC} Min.						
iliput voltage	VIL	20 % V _{CC} Max.			- ST terminal			
Rise time and Fall time	tr / tf	3 ns Max. 3.5 ns Max. (@1.8 V±10 %)		20 % V _{CC} to 80 % V _{CC} level, L_CMOS = 15 pF				
Start-up time	t_str	3 ms Max.		T = 0 at 90 % Vcc				
Frequency aging	f_age	±3 × 10 ⁻⁶ / year Max.		+25 °C,	First year			

[Model: SG2016/3225/5032/7050CAN]

Product name (Standard form) $\frac{\text{SG2016 C AN}}{\textcircled{2}} \underbrace{25.000000MHz}_{25.000000MHz} \underbrace{\text{T J G A}}_{\textcircled{3}} \underbrace{(\$\$)}_{\textcircled{6}} \cdot \text{Available code DB, JB, JG, JH, LG, LH)}_{\textcircled{3}}$

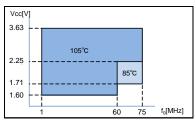
①Model ②Output(C:CMOS) ③Frequency ④Supply voltage

⑤Frequency tolerance ⑥Operating temperature range ⑦Internal identification code("A" is default)

_	, ,	
4)St	ipply voltage	See *1
Т	1.60 to 3.63 V	
K	2.25 to 3.63 V	

⑤Frequency tolerance				
D	±25 × 10 ⁻⁶			
J	±50 × 10 ⁻⁶			
L	±100 × 10 ⁻⁶			

60	⑥Operating temperature range				
В	-20 °C to +70 °C				
G	-40 °C to +85 °C				
Н	-40 °C to +105 °C				



[Model: SG-210STF]

Product name SG-210 S T F 25.000000MHz L (Standard form) © ②3 ④ ⑤

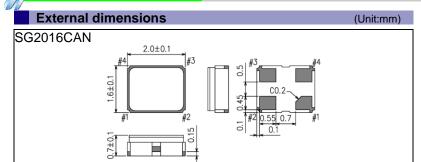
①Model ②Function(S:Standby) ③Supply voltage ④Frequency ⑤Frequency tolerance

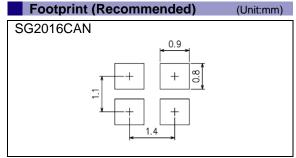
3 S	See *1	
Т	1 60 to 3 63 V	

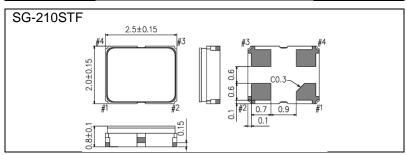
(5)Fr	⑤Frequency tolerance				
S	±25 × 10 ⁻⁶ / -20 °C to +70 °C				
L	±50 × 10 ⁻⁶ / -40 °C to +85 °C				
Υ	±50 × 10 ⁻⁶ / -40 °C to +105 °C				
W	±100 × 10 ⁻⁶ / -40 °C to +105 °C				

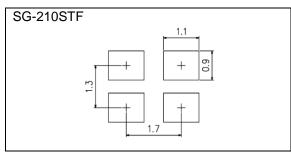
*1 : The upper limit of Operating temperature and the related conditions

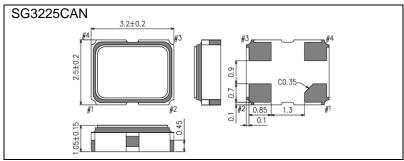
Please note that Supply voltage range (V_{CC}) depends on Output frequency(fo) and upper limit of Operationg temperature(T_use Max.).

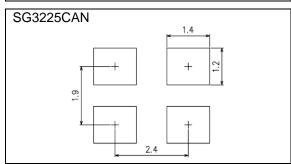


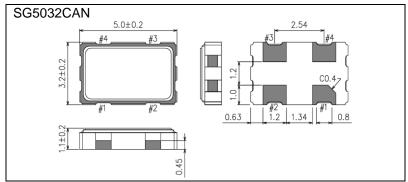


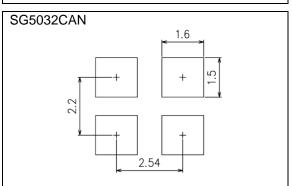


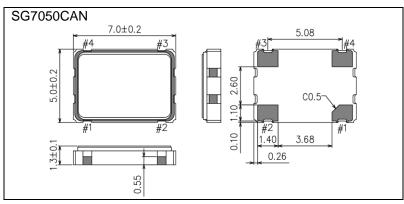


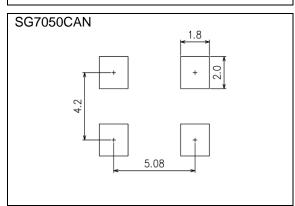












Pi	n	NΛ	an

Pin	Connection	Function				
		ST terminal				
1	ST		ST function	Oscillator circuit	Output	
1	31		HIGH or "open"	Oscillation	Specified frequency: Enable	
			LOW	Oscillation stop	High impedance: Disable	
2	GND	Ground				
3	OUT	Clock output				
4	V_{CC}	Power s	supply	·		

■Notes: To maintain stable operation, provide a 0.01uF to 0.1uF by-pass capacitor at a location as near as possible to the power source terminal of the crystal product (between Vcc - GND).

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

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►Pb free.



► Complies with EU RoHS directive.

*About the products without the Pb-free mark.

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(Contains Pb in sealing glass, high melting temperature type solder or other.)



▶ Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.



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